Specification
规格书

Customer Name: _____
客户名称

Customer P/N: _____
客户品号

Product P/N: GS-3528WXXX-1CZ-LX-R80-BL
产品型号

Sending Date: _____
供货日期

☐ Technical Reference 技术参考			☐ Sample 样品		■Mass Product 量产供货
Customer approval 客户审核			GM approval 光脉审核		
Approved 核准	Audit 确认	Confirmation 制作	Approved 核准	Audit 确认	Confirmation 制作
		WL			
☐ Qualified 接受	☐ Disqualified 不接受		Date: 日期:		

RoHS

ISO 9001 (本企业已通过ISO9001质量管理体系认证)

ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
SENSITIVE DEVICES

GUANGMAI TECHNOLOGY CO., LTD
地址（Add）：广东省深圳市宝安区燕罗街道广田路 96 号光脉科技园-WL
电话（Tel）: +86-13480887485 Email: info@gmleds.com 网址: www.gmleds.com 微信/wechat: gmleds

Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

■ Features 产品特征：

- 体积小，光效高

Small package with high efficiency

- 电压低，瞬间点亮

Low voltage operation, Instant light

- 工作寿命长 Long operation life
- 通过 RoHS 认证 RoHS compliant

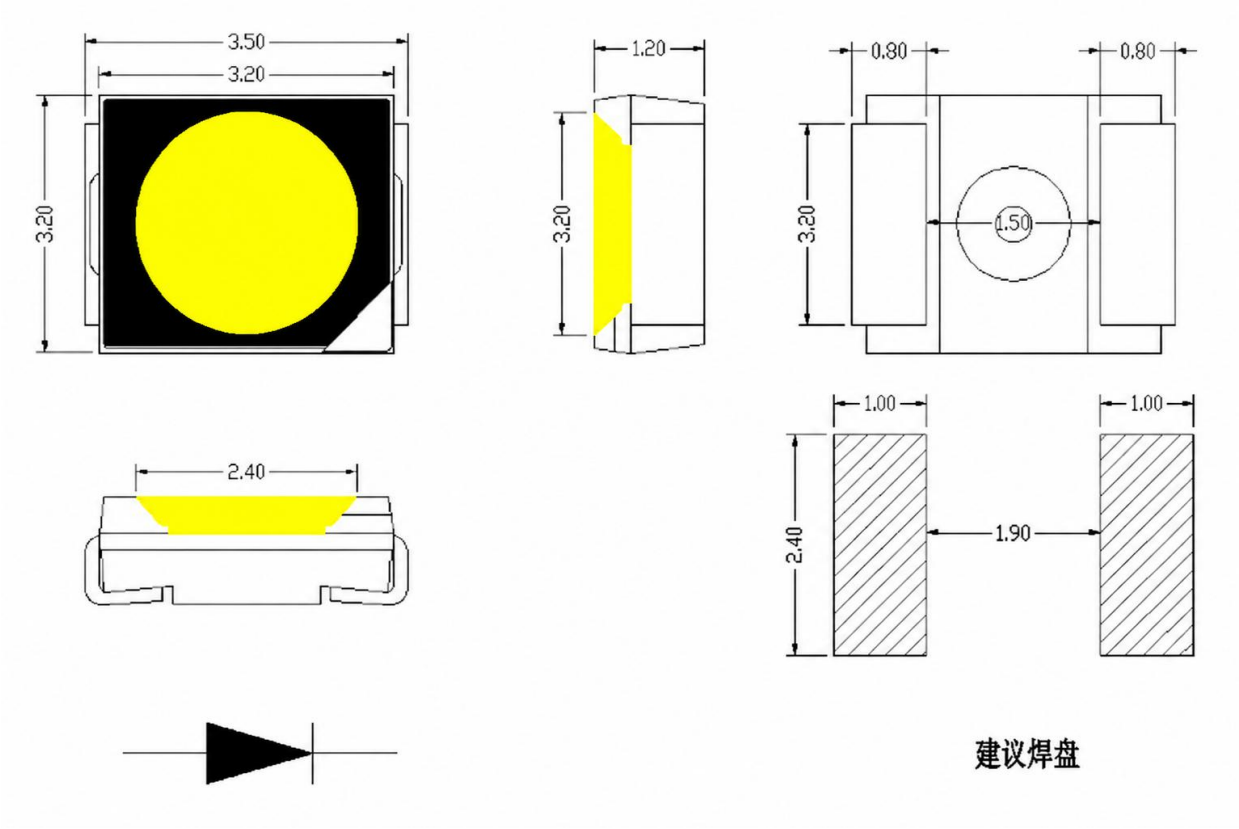


■ Applications 产品应用：

- 室内通用照明 Indoor General Lighting
- 建筑装饰照明 Architectural / Decorative Lighting
- 传统照明替换 Traditional lighting replacement
- 汽车灯 Automotive forward lighting
- 植物照明 Planting lighting

Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

■ Package Dimensions 封装外形尺寸



Notes: All dimensions in mm tolerance is ±0.1mm unless otherwise noted.
除非另有说明，以上尺寸以 mm 为单位，公差在±0.1mm。

Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

■ Absolute Maximum Ratings(At TA =25℃) 极限参数

Parameter	Symbol	Rating	Unit
DC Forward Current (正向电流)	I_F	30	m A
Peak pulse Current* (脉冲电流)	I_{FP}	40	m A
Power Dissipation (功率)	P_D	0.06	W
Reverse Voltage (反向电压)	V_R	5	V
Reverse Current (反向电流)	I_R	10	μ A
Operating Temperature Range (工作温度)	T_{OPR}	-40 ~ +85	°C
Storage Temperature Range (储存温度)	T_{STG}	-40 ~ +100	°C
LED Junction Temperature (结点温度)	T_J	120	°C

Note: 备注

1. 1/10 Duty cycle, 0.1ms pulse width. 脉宽 0.1ms,周期 1/10。
2. Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product. 使用功率不能超过规定的最大值。
3.When the LEDs are in operation the maximum current should be decided after measuring the package temperature, junction temperature should not exceed the maximum rate. LED 使用最大电流需根据散热条件确定，结温不能超过最大值。

Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

■ Electrical/Optical Characteristics--White (At T_A=25°C) 光电特性参数

Parameter	Symbol	Conditions	Min	Avg.	Max	Units
Forward Voltage （正向压降）	V_F	I_F=20mA	2.80	--	3.40	V
Luminous Flux （光通量）	Φv	I_F=20mA	7		10	lm
CRI （显色指数）	Ra	I_F=20mA	80	--	--	--
Color tolerance 色容差		I_F=20mA	--	--	5	SDCM
Temperature Coefficient of Forward Voltage （正向压降之温度系数）	$\Delta V_F/\Delta T$	I_F=20mA	--	-2	--	mV/°C
Reverse Current （反向漏电流）	I_R	V_R=5V	--	--	10	μA
Viewing Angle [1] （发光角度）	$2\Theta_{1/2}$	I_F=20mA	--	120	--	Deg
Thermal Resistance Junction To Board （热阻）	$R\Theta_{J-B}$	I_F=20mA	--	10	--	°C/W

Note:(备注）

1. The above forward voltage measurement allowance tolerance is ±0.1V。
以上所示电压测量误差±0.1V
2. The above luminous flux measurement allowance tolerance is ±10%。
上述发光通量的测试允许公差为±10%
3. The above Color Rendering Index measurement allowance tolerance is ±2。
以上显色性指数的测试允许公差为±2
4. The above color coordinates measurement allowance tolerance is ±0.003。
以上所示坐标测量误差 ±0.003。
5. 2θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value。
2q1/2 是半值角,指光强是光学中心线光强的 1/2 处到光学中心线的角度

Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

■Luminous Flux BIN, IF=20 mA TA =25℃

Part Number	Symbol（符号）	Min（最小）	Avg（平均）.	Max（最大）	Units（单位）
GS-3528WXXX-1CZ-L7-R80-BL	Φv	7	--	8	lm
GS-3528WXXX-1CZ-L8-R80-BL	Φv	8	--	9	lm
GS-3528WXXX-1CZ-L9-R80-BL	Φv	9	--	10	lm

■Color Temperature 色温 IF=20 mA TA =25℃

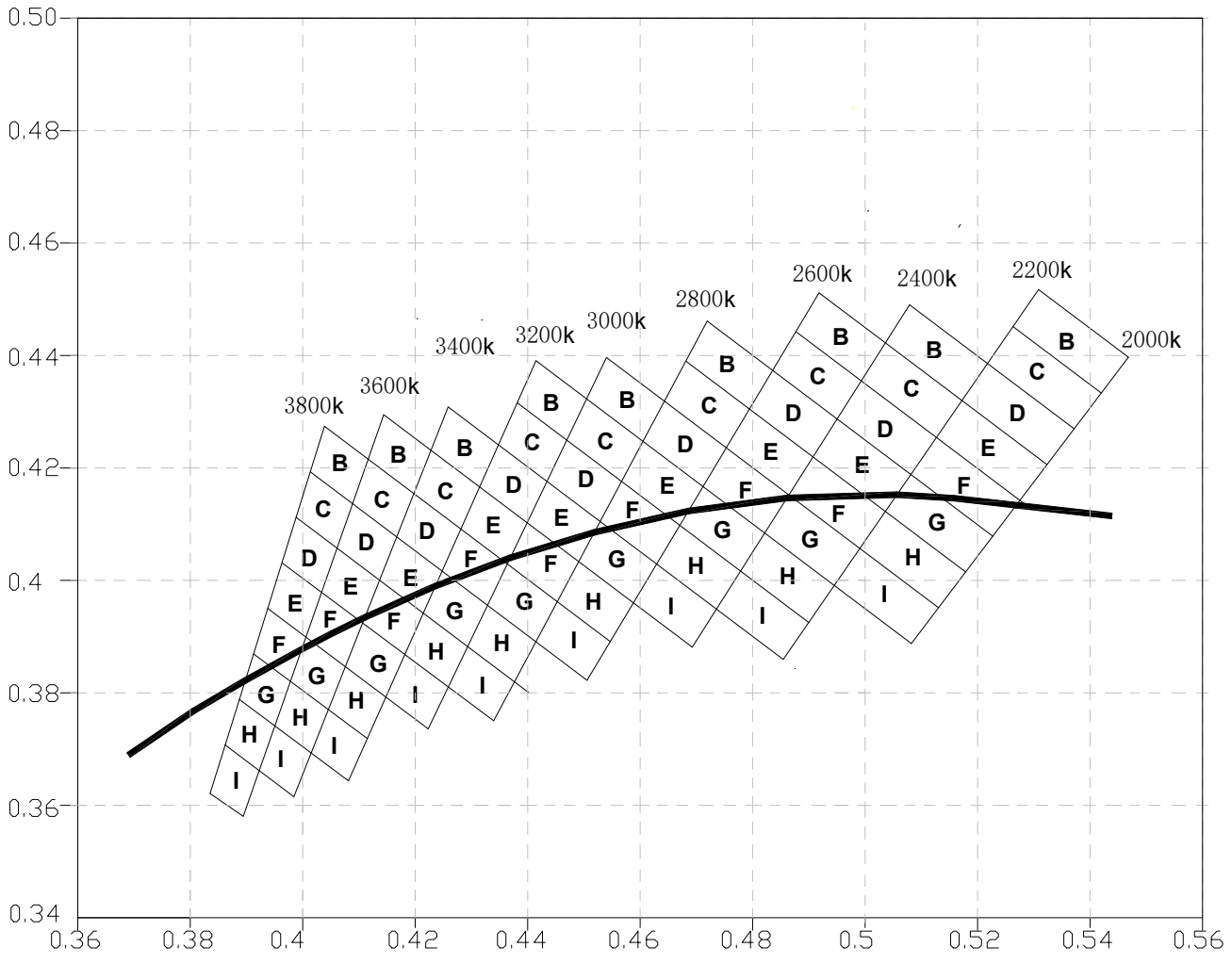
Parameter	Symbol	Conditions	Min	Avg.	Max	Units
PN: GS-3528W270-1CZ-LX-R80-BL	CCT	I_F=20mA	2600	2700	2800	K
PN: GS-3528W300-1CZ-LX-R80-BL	CCT	I_F=20mA	2900	3000	3100	K
PN: GS-3528W350-1CZ-LX-R80-BL	CCT	I_F=20mA	3300	3500	3700	K
PN: GS-3528W400-1CZ-LX-R80-BL	CCT	I_F=20mA	3700	4000	4300	K
PN: GS-3528W500-1CZ-LX-R80-BL	CCT	I_F=20mA	4700	5000	5300	K
PN: GS-3528W570-1CZ-LX-R80-BL	CCT	I_F=20mA	5400	5700	6000	K
PN: GS-3528W650-1CZ-LX-R80-BL	CCT	I_F=20mA	6000	6500	6900	K
Color tolerance 色容差		I_F=20mA	--	--	5	SDCM
CRI （显色指数）	Ra	I_F=20mA	80	--	--	--

Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

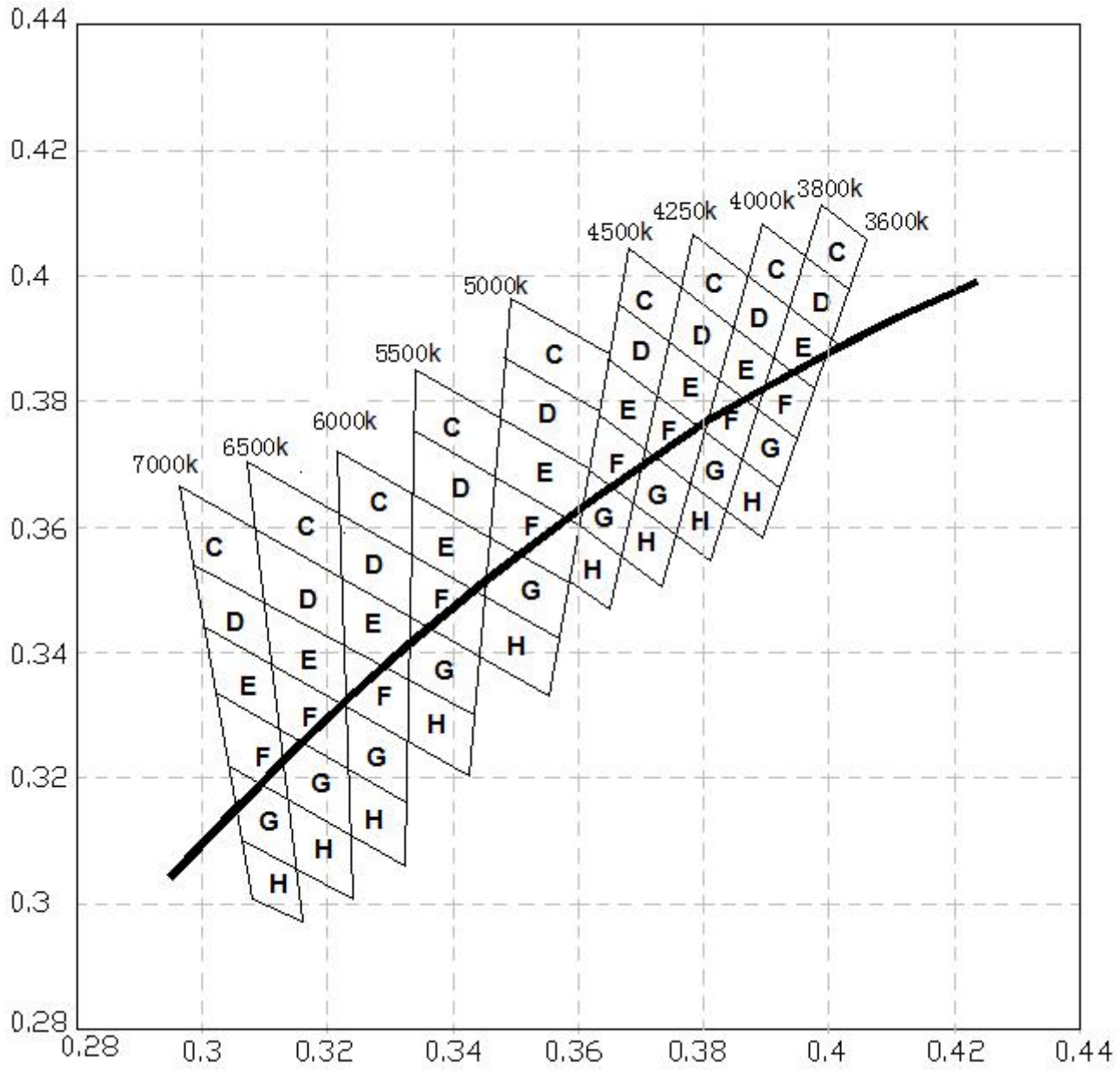
■Forward Voltage BIN, IF=20 mA TA =25℃

BIN	Symbol（符号）	Min（最小）	Avg（平均）.	Max（最大）	Units（单位）
V2-6	V_F	2.60	--	2.80	V
V2-8	V_F	2.80	--	3.00	V
V3-0	V_F	3.00	--	3.20	V
V3-2	V_F	3.20	--	3.40	V

■ Color & binning 色区分级



Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice



Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

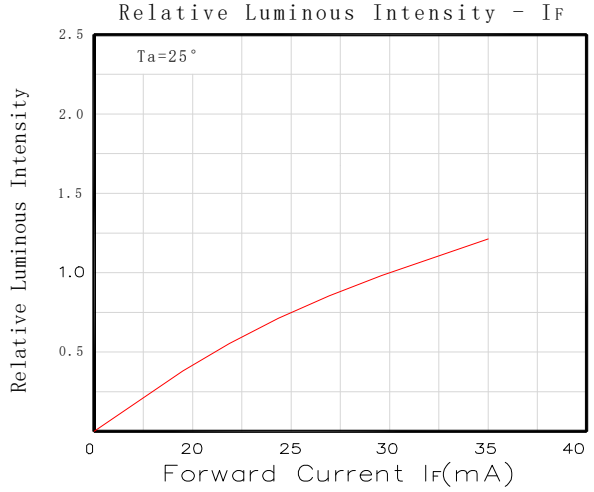
20E 2000-2200K	0.5172	0.432	20F 2000-2200K	0.5127	0.4254	22E 2200-2400K	0.495	0.4287	22F 2200-2400K	0.4907	0.4219
	0.5324	0.4206		0.5275	0.4142		0.5082	0.4188		0.5036	0.4122
	0.5275	0.4142		0.5227	0.4078		0.5036	0.4122		0.4991	0.4057
	0.5127	0.4254		0.5082	0.4188		0.4907	0.4219		0.4865	0.4152
24E 2400-2600K	0.4795	0.4304	24F 2400-2600K	0.4753	0.4236	26E 2600-2800K	0.4605	0.4247	26F 2600-2800K	0.4567	0.4176
	0.4907	0.4219		0.4865	0.4152		0.4712	0.4167		0.4671	0.4098
	0.4865	0.4152		0.4822	0.4084		0.4671	0.4098		0.463	0.4029
	0.4753	0.4236		0.4712	0.4167		0.4567	0.4176		0.4529	0.4105
28E 2800-3000K	0.4434	0.4176	28F 2800-3000K	0.4399	0.4102	30E 3000-3200K	0.4315	0.4166	30F 3000-3200K	0.4281	0.4091
	0.4529	0.4105		0.4491	0.4033		0.4399	0.4102		0.4364	0.4029
	0.4491	0.4033		0.4453	0.3962		0.4364	0.4029		0.4327	0.3951
	0.4399	0.4102		0.4364	0.4029		0.4281	0.4091		0.4248	0.4016
32E 3200-3400K	0.4167	0.4077	32F 3200-3400K	0.4137	0.4	34E 3400-3600K	0.4061	0.4057	34F 3400-3600K	0.4033	0.3978
	0.4248	0.4016		0.4214	0.3942		0.4137	0.4		0.4106	0.3923
	0.4214	0.3942		0.4181	0.3867		0.4106	0.3923		0.4076	0.3846
	0.4137	0.4		0.4106	0.3923		0.4033	0.3978		0.4006	0.3899
36E 3600-3800K	0.3963	0.4031	36F 3600-3800K	0.3938	0.395	38E 3800-4000K	0.3848	0.3918	38F 3800-4000K	0.3825	0.3835
	0.4033	0.3978		0.4006	0.3899		0.3913	0.3869		0.3887	0.3788
	0.4006	0.3899		0.3978	0.382		0.3887	0.3788		0.3862	0.3707
	0.3938	0.395		0.3913	0.3869		0.3825	0.3835		0.3802	0.3752
40E 4000-4250K	0.3746	0.3895	40F 4000-4250K	0.3726	0.3809	42E 4250-4500K	0.3649	0.3868	42F 4250-4500K	0.3633	0.3779
	0.3825	0.3835		0.3804	0.3751		0.3726	0.3809		0.3707	0.3724
	0.3804	0.3751		0.378	0.3669		0.3707	0.3724		0.3688	0.3639
	0.3726	0.3809		0.3707	0.3724		0.3633	0.3779		0.3618	0.3691
45E 4500-5000K	0.3475	0.3775	45F 4500-5000K	0.3467	0.3679	50E 5000-5500K	0.3327	0.3659	50F 5000-5500K	0.3326	0.3559
	0.3618	0.3693		0.3603	0.3602		0.3459	0.3584		0.345	0.3489
	0.3603	0.3602		0.3587	0.3511		0.345	0.3489		0.3442	0.3393
	0.3467	0.3679		0.3459	0.3584		0.3326	0.3559		0.3325	0.3459
55E 5500-6000K	0.3224	0.3517	55F 5500-6000K	0.3227	0.3415	60E 6000-6500K	0.3102	0.3486	60F 6000-6500K	0.3117	0.3377
	0.3325	0.3459		0.3325	0.336		0.3227	0.3415		0.323	0.3313
	0.3325	0.336		0.3324	0.326		0.323	0.3313		0.3234	0.3211
	0.3227	0.3415		0.323	0.3313		0.3117	0.3377		0.3133	0.3268
65E 6500-7000K	0.3009	0.3438	65F 6500-7000K	0.3032	0.3325	70E 7000-7500K	0.293	0.3383	70F 7000-7500K	0.2961	0.3265
	0.3117	0.3377		0.3133	0.3268		0.3032	0.3325		0.3055	0.3212
	0.3133	0.3268		0.3148	0.316		0.3055	0.3212		0.3078	0.3099
	0.3032	0.3325		0.3055	0.3212		0.2961	0.3265		0.2992	0.3148

Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

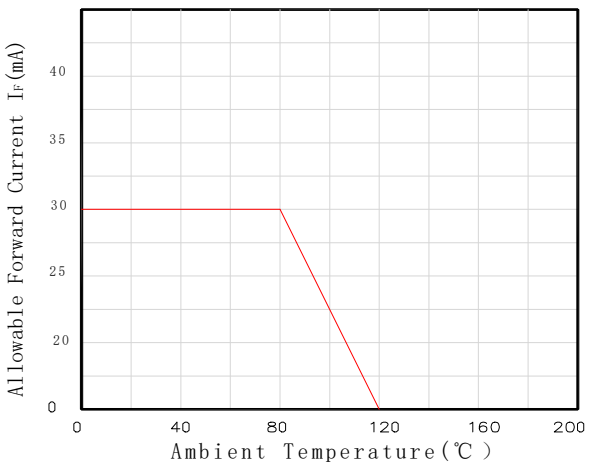
■ Typical Optical/Electrical Characteristics Curves 典型光电参数曲线

(Ta=25℃ Unless Otherwise Noted)

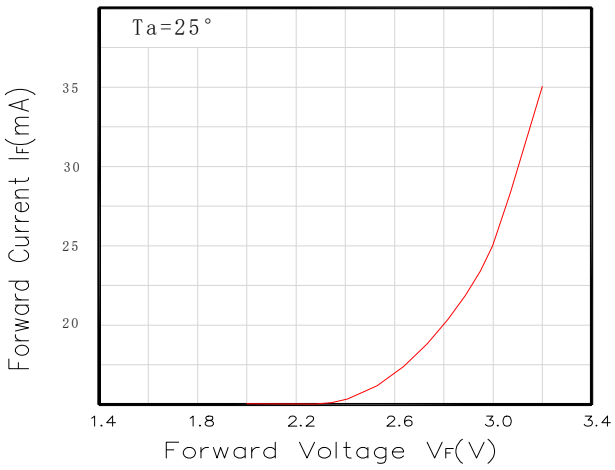
Relative Luminous Intensity - IF



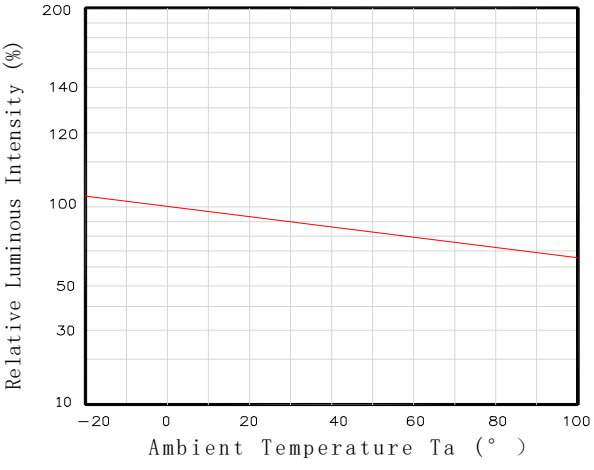
Allowable Forward Current - Ta



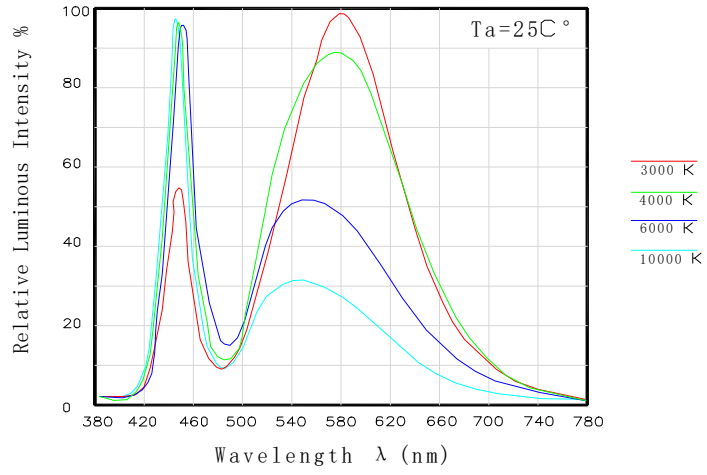
IF - VF

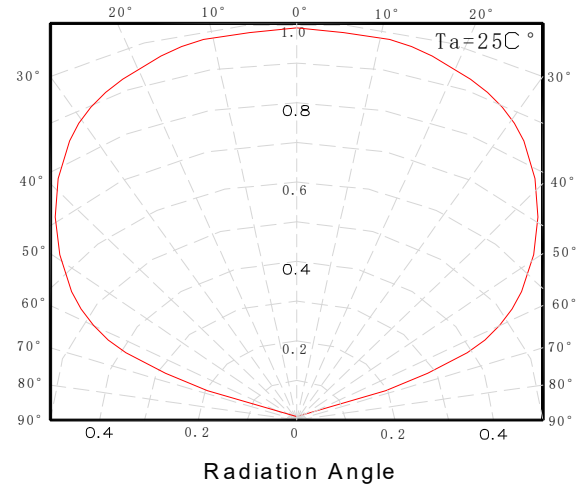


Relative Luminous Intensity - Ta



Wavelength Characteristics





Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

■Reliability test standards 可靠性实验标准

测试项目 Test Item	参考标准 REF. Standard	测试条件 Test condition	持续时间 Duration	取样数 Sample count	允收数 Accept
温度循环 Temperature Cycle	JESD22-A104 -A	100℃±5 30min~25℃ 30min,5min,30min,5min	循环 100 次 100 cycles	22	0/22
冷热冲击 Thermal shock	JESD22-A106	-40℃~100℃ 30min, 30min	循环 100 次 100 cycles	22	0/22
高温储存 High Temperature Storage	JEITA ED-4701 200 201	TA=100℃±5℃	1000 Hrs	22	0/22
低温储存 Low Temperature Storage	JEITA ED-4701 200 202	TA=-40℃±5℃	1000 Hrs	22	0/22
高温/高湿储存 Humidity Heat Storage	JIS C 7021 (1977)B-11	Ta=60℃ RH=85%	1000Hrs	22	0/22
寿命测试 Life test	JESD22-A108 -A	Ta=25℃ If=20mA	1000Hrs	22	0/22
高温/高湿寿命测试 High humidity Heat life test	JESD22-A101	Ta=60℃ RH=85% IF=20mA	1000Hrs	22	0/22

Criteria For Judging Damage 失效判定标准：

Test Item 项目	Symbol 符号	Test condition 测试条件	Criteria For Judgement 判定标准	
			Min.最小	Max.最大
Forward Voltage 正向电压	VF	IF=20mA	--	U.S.L*)1.1
Reverse Current 反向电流	IR	VR=5V	--	10uA
Luminous Flux 光通量	Lm	IF=20mA	L.S.L*)0.7	--
Lamp bead lighting test 灯珠点亮测试	/	IF=20mA	无开路、短路、闪变	

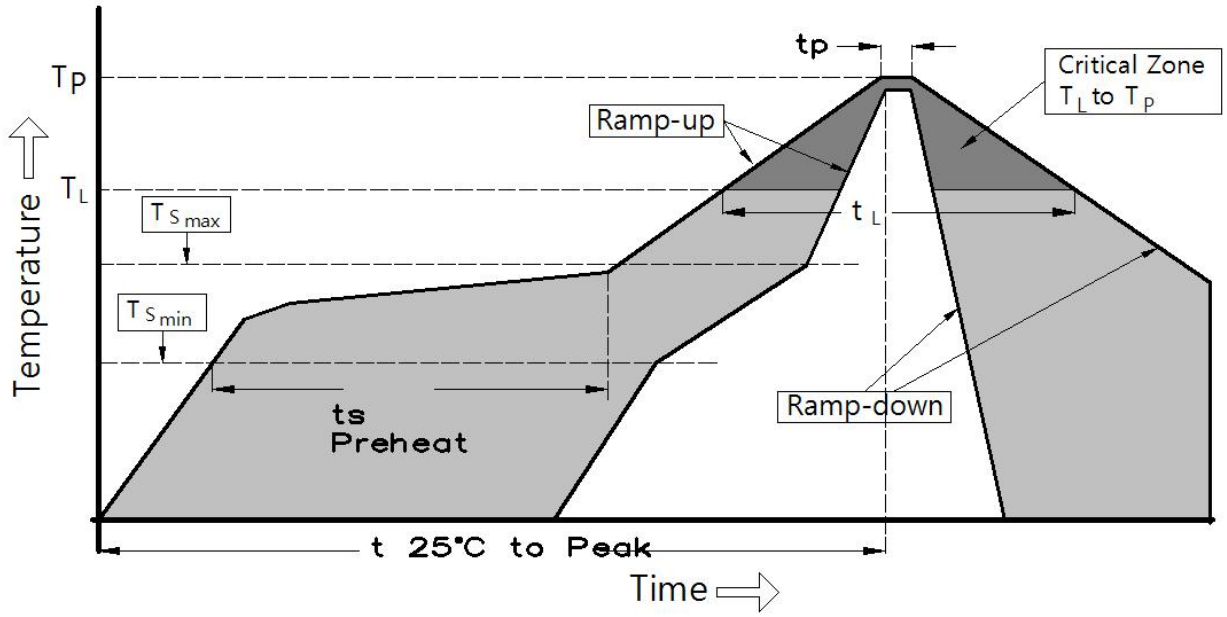
U.S.L：Upper standard level 规格上限　　L.S.L：Lower standard level 规格上限

Note 备注：

The above technical data is only the typical value of the product, not as any application conditions and application mode guarantee.以上技术数据仅为产品的典型值，不作为任何应用条件及应用方式的保证。

Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

■SMT ReflowSoldering Instructions SMT 回流焊说明



平均升温速度（Tsmax 至 Tp）	最高 3 ° C/秒
预热：最低温度 (Tsmin）	130 ° C
预热：最高温度 (Tsmax）	180 ° C
预热：时间（tsmin 至 tsmax）	60 - 120 秒
限时维持高温：温度 (TL)	200 ° C
限时维持高温：时间 （tL）	最多 60 秒
峰值 / 分类温度 (Tp)	240 ° C
限时峰值分类温度:时间（tp）	最多 10 秒
与实际峰值温度 (tp) 低 5 ° C 以内的保持时间	最多 30 秒
降温速度	最高 6 ° C/ 秒
25 ° C 升至峰值温度所需时间	最多 8 分钟

●Notes for reflow [if reflow products are needed]回流焊注意事项[如需回流焊产品]

1.Reflow soldering should not be done more than two times. In the case of more than 24 hours passed soldering after first, LEDs will be damaged. 回流焊次数不可以超两次，两次回流焊时间间隔如果超过 24 小时，LED 可能由于吸湿而损坏

2.When welding, do not press hard on the colloid surface when the material is heated.
当焊接时，不要在材料受热时用力压胶体表面。

3.Scrape the heat-conducting solder paste on the aluminum base plate, stir the solder paste clockwise for 10-15 minutes before scraping the solder paste, and place the aluminum base plate on the solder paste scraping tool. Scrape the solder paste evenly and thickly

Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

板上刮导热锡膏,刮锡膏前锡膏要顺时针搅拌 10-15 分钟,把铝基板放在刮锡膏工装上，锡膏要刮的均匀，厚度要适宜。

4.Scrape solder paste steel mesh needs to be made into a cross, so as to allow air circulation, avoid solder paste lifting caused by LED poor heat dissipation 刮锡膏钢网需做成十字架，好让空气流通，避免锡膏抬起造成 LED 光源散热不良。

5.Note that the lamp should be installed flat and the two pins of the LED light source should be installed on the welding pad position of the aluminum substrate. 注意灯要装平，LED 光源的两个管脚要装在铝基板的焊盘位上。

6.Scrape the aluminum base plate of solder paste in 2 hours to install all the light source, light source installed in the aluminum base plate, the operator should self-check whether the light source is installed (can't have reverse, light source bottom suspension) to tilt 45 degrees Angle to check each light source 刮好锡膏的铝基板在 2 小时内要全部装好光源，光源的装在铝基板后，作业员要自检光源是否装好（不能有反向，光源底部悬空）要倾斜 45 度角检查每颗光源。

7.After reflow welding, check whether the light source is in the position of the welding pad, and do not have eccentric phenomenon, or the line will be broken in the second light distribution lens, resulting in open circuit.过完回流焊后要检查光源是否在焊盘位置上，不能有偏心现象，否则在上二次配光透镜时会把线拉断，造成开路。

8.Rapid cooling is not allowed after reflow soldering.回流焊后，不允许快速冷却。

9.Do not weld on deformed PCB.禁止焊接在变形 PCB 板上。

●SolderingIron 烙铁焊接

1.When hand soldering, keep the temperature of iron below less 300℃ less than 3 seconds.
当手工焊接时，烙铁的温度必须小于 300℃，时间不可超过 3 秒。

2.The hand solder should be done only one time.手工焊接只可焊接一次。

●Repairing 修补

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable,a double-head soldering iron should be used (as below figure). It should be confirmed in advance whether the characteristics of LEDs will or will not be damaged by repairing.
LED 回流焊后不应该修复，当必须修复时，必须使用双头烙铁，而且事先应确认此种方式会不会损坏 LED 本身的特性。

●Cautions 注意事项

1.LED packaging is silica gel, so the LED colloidal surface is soft, hard pressure on the colloidal surface will affect the LED reliability, so there should be preventive measures to avoid the strong pressure on the package parts, when the suction nozzle, the pressure on the colloidal surface should be appropriate.LED 封装为硅胶，故 LED 胶体表面较软，用力按压胶体表面会影响 LED 可靠性，因此应有预防措施避免在封装的零件上的强大压力，当使用吸嘴时，胶体表面的压力应是恰当的。

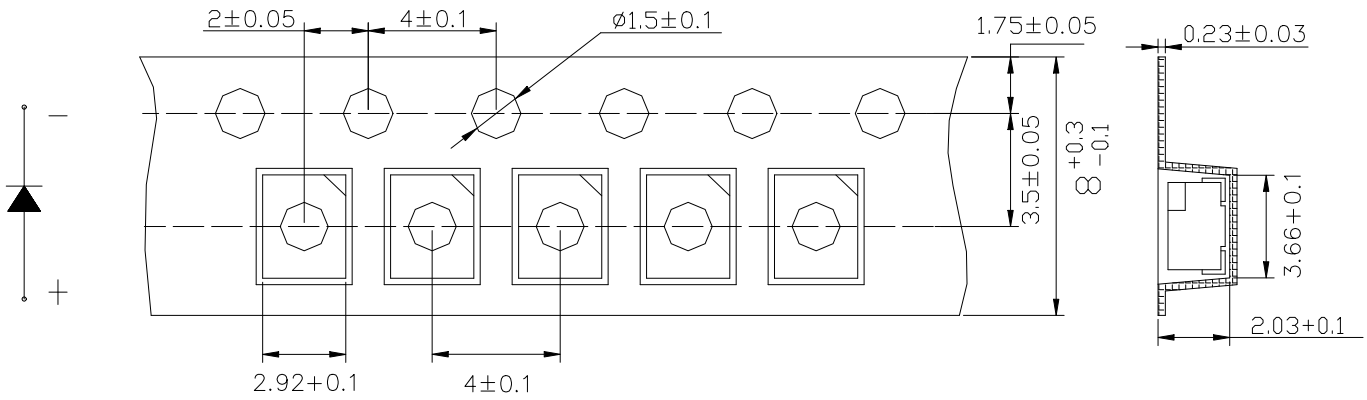
2.Components should not be mounted on warped (non coplanar) portion of PCB. After soldering, do not warp the circuit board.LED 灯珠不要焊接在弯曲的 PCB 板上，焊接之后，也不要弯折线路板。

3.Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering. Do not rapidly cool device after soldering. 回流焊之后冷却过程中，不要对材料实加外力，也不要有震动，回流焊后，不要采用激剧冷却的方式。

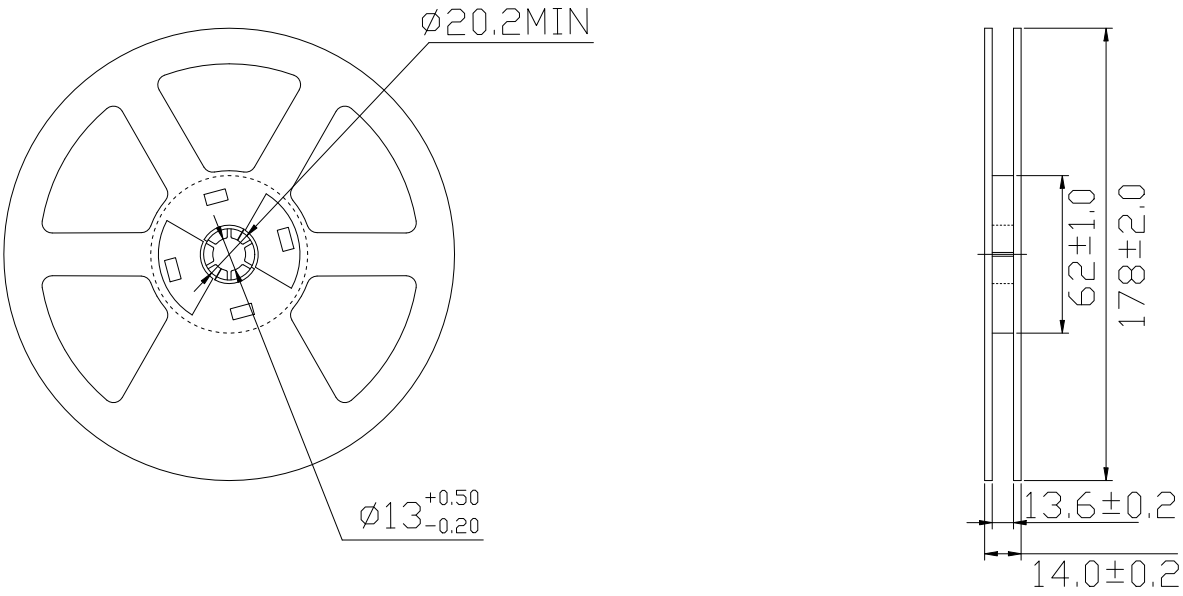
Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

■ Packing Standard 包装标准

Normal packing quantity: 4000pcs/reel 正常包装数量：4000 片/卷



Reel Specifications 卷盘规格



Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

Label 标签



IF（mA）:正向电流

VF（V）：正向电压

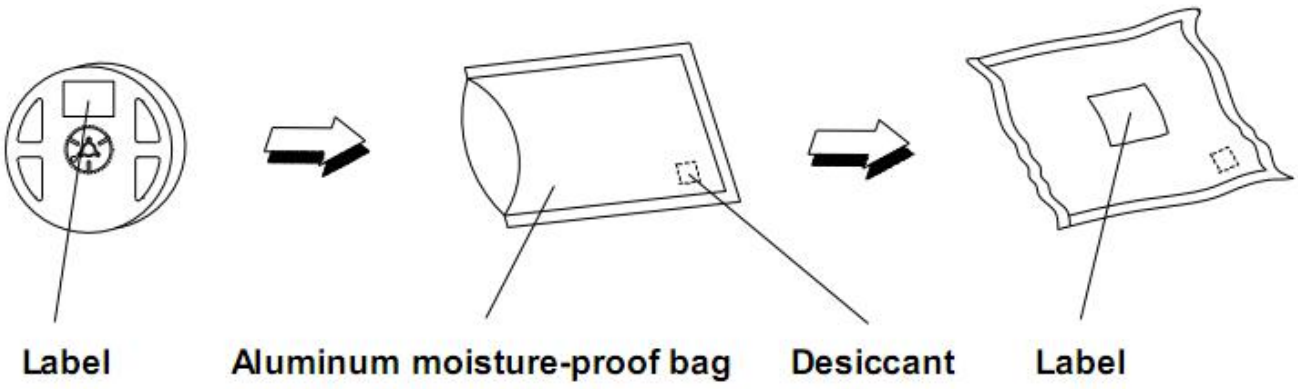
Φ（Lm）：光通量

TC（K）：色温

Ra：显指

PCS：数量

Moisture Resistant Packaging 防潮包装



Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

■Product specification 产品使用说明

一、Storage/use 储存/使用：

1.In order to avoid moisture absorption, it is suggested to store the products in a drying cabinet with desiccant. The storage temperature is 5℃~30℃, and the humidity is ≤60%HR 为避免吸潮建议将产品贮存在放有干燥剂的干燥柜中，贮存温度为：5℃~30℃，湿度：≤60%HR。

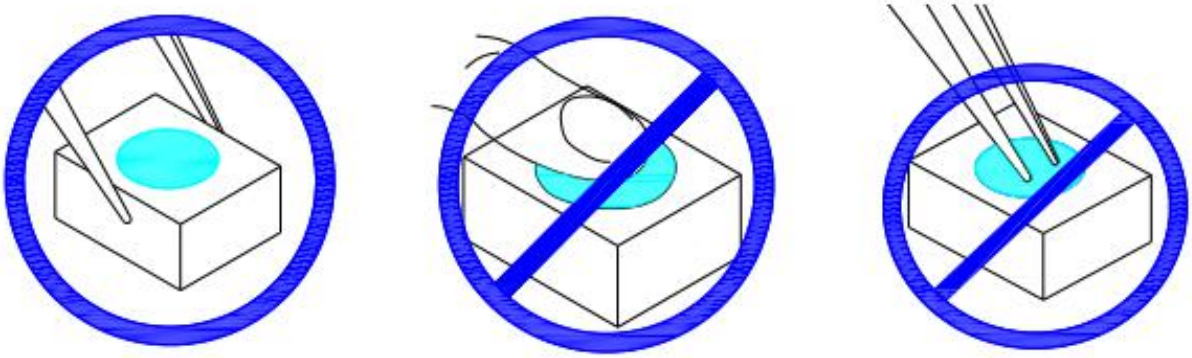
2. After storage for six months, it is recommended to re-use the spectral separation to prevent changes in photoelectric parameters 储存六个月之后建议重新分光分色后使用，防止光电参数发生变化。

3.It is recommended to dry products that have been sealed and stored for more than six months before use. The drying condition is 65℃±5℃ for 10 hours 密封储存六个月以上的产品使用前，建议干燥，干燥条件为：65℃±5℃10 个小时。

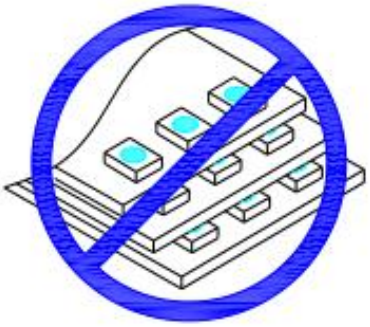
4.The product shall be used within 24h after opening, otherwise it shall be baked at 65℃ for 4-6h before reflow welding 产品开封 24h 内需使用完毕，否则需 65℃ 烘烤 4-6h 后再过回流焊。

5、Repackage unused products in moisture-proof bags and store in a dry place 重新包装未使用的产品置防潮袋密封好之后贮存在干燥的地方。

二、 Handle the component along the side surface by using forceps or appropriate tools; do not directly touch or Handle the silicone lens surface, it may damage the internal circuitry.通过使用适当的工具从材料侧面夹取，不可直接用手或尖锐金属压胶体表面，它可能会损坏内部电路。



三、Do not stack module materials together; they may damage internal circuits 不可将模组材料堆积在一起，它可能会损坏内部电路。



Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice

四、Products should not be in contact with water, oil or organic solutions。产品不得接触水、油、有机溶液。

五、The operating current value of the product should consider LED junction temperature 产品使用工作电流大小值应考虑 LED 结温。

六、External dimensions are subject to change without prior notice 产品外观尺寸可更改而不另行通知。

七、Anti-static requirements: when using products, must wear anti-static ring or anti-static gloves, all equipment, devices, machines must be effectively grounded. This product belongs to electrostatic sensitive device, pay attention to anti-static protection!防静电要求：使用产品时，必须戴防静电环或防静电手套，所有设备、装置、机台必须有效接地。该产品属于静电敏感器件，注意做好防静电保护！

八、When LED working, push the temperature of PCB board should not exceed 60℃.当 LED 工作时，推存 PCB 板的温度不要超过 60℃。

九、.LED operating environment and sulfur element composition cannot be over 100PPM in the LED mating usage material. This is provided for informational purposes only and is not a warranty or endorsement。工作环境及与 LED 适配的材料中，硫元素及化合物成份不可超过 100PPM，单一的溴元素含量要求小于 900PPM，单一氯元素含量要求小于 900PPM，溴元素与氯元素总含量必须小于 1500PPM（检测含量为与 LED 直接接触面上元素含量）。

十、VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues. advises against the use of any chemicals or materials that have been found or are suspected to have an adverse affect on device performance or reliability. To verify compatibility, recommends that all chemicals and materials be tested in the specific application and environment for which they are intended to be used. Attaching LEDs, do not use adhesives that outgas organic vapor.应用套件中的挥发性物质会渗透到 LED 内部，可能对 LED 性能或者可靠性不利，在通电情况下会加剧影响。因此客户需提前验证，避免套件材料或其他组装原物料存在未经验证的挥发性物质，针对特定的用途和使用环境，建议对所有的物质和材料进行相容性的测试。

十一、When the customer applies LED, it shall refer to the parameters of this specification and the requirements of operating environment. If the LED is used beyond the parameters or standard conditions without verification, our company will not make any quality guarantee。客户在应用 LED 时，需参考此规格书参数及使用环境要求，未经验证情况下超出参数或标准条件使用，我司不作任何品质担保。

十二、Other points for attention,please refer to our LED user manual.其它注意事项请参照我们的 LED 使用手册。

■Declare 申明

This specification is written both in English and in Chinese and the latter is formal。
此规格书以中英文方式书写，若有冲突以中文版本为准。

Copyright © 2026 GMKJ . All rights reserved . Subject to change without notice